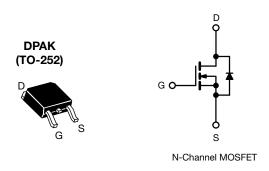
**Vishay Siliconix** 



## **E Series Power MOSFET**



PRODUCT SUMMA	RY	
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650	)
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.269
Q <sub>g</sub> max. (nC)	64	
Q <sub>gs</sub> (nC)	8	
Q <sub>gd</sub> (nC)	13	
Configuration	Sing	le

### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	DPAK (TO-252)
	SiHD14N60E-GE3
Lood (Ph) free and halogen free	SiHD14N60ET1-GE3
Lead (Pb)-free and halogen-free	SiHD14N60ET4-GE3
	SiHD14N60ET5-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	600	V	
Gate-source voltage			V <sub>GS</sub>	± 30	V	
Continuous drain current ( $T_{,1} = 150 \ ^{\circ}C$ )	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	- I <sub>D</sub>	13		
Continuous drain current $(1) = 150^{\circ}$ C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		8	А	
Pulsed drain current <sup>a</sup>		I <sub>DM</sub>	32	1		
Linear derating factor			1.2	W/°C		
Single pulse avalanche energy <sup>b</sup>		E <sub>AS</sub>	136	mJ		
Maximum power dissipation		PD	147	W		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-source voltage slope $T_J = 125 \text{ °C}$			70			
Reverse diode dV/dt <sup>d</sup>		dV/dt	32	V/ns		
Soldering recommendations (peak temperature) <sup>c</sup>	oldering recommendations (peak temperature) c for 10 s			300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature b.  $V_{DD} = 140 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ , L = 28.2 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = 3.1 \text{ A}$  c. 1.6 mm from case d.  $I_{SD} \leq I_D$ , dl/dt = 100 A/µs, starting  $T_J = 25 \text{ °C}$ 

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THERMAL RESISTANCE RAT			1					
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-		62			°C/W	
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-		0.85				
SPECIFICATIONS (T <sub>J</sub> = 25 °C, u	inless otherwi	ise noted)						
PARAMETER	SYMBOL			ONS	MIN.	TYP.	MAX.	UNI
Static					I			
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	50 µA	600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$		e to 25 °C, I		-	0.73	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>		= V <sub>GS</sub> , I <sub>D</sub> = 2		2.0	-	4.0	V
· · ·			$V_{GS} = \pm 20^{\circ}$		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	,	$V_{GS} = \pm 30$ V	/	-	-	± 1	μA
		V <sub>DS</sub> =	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1	μA
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 480 V	<sup>7</sup> , V <sub>GS</sub> = 0 V,	<sub>S</sub> = 0 V, T <sub>J</sub> = 125 °C		-	10	
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	١ <sub>٢</sub>	<sub>0</sub> = 7 A	-	0.269	0.309	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub> =	: 7 A	-	3.8	-	S
Dynamic	•	-			*	•		
Input capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,		-	1205	-	
Output capacitance	C <sub>oss</sub>	- ·	$V_{DS} = 100 V$	3	-	62	-	
Reverse transfer capacitance	C <sub>rss</sub>		f = 1 MHz		-	5	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	N 01			-	52	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>	$V_{DS} = 0.0$	′ to 480 V, V	<sub>GS</sub> = 0 V	_	177	-	
Total gate charge	Qg				-	32	64	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 7 A	, V <sub>DS</sub> = 480 V	-	8	-	nC
Gate-drain charge	Q <sub>gd</sub>				-	13	-	
Turn-on delay time	t <sub>d(on)</sub>				-	15	30	
Rise time	t <sub>r</sub>	Vas	= 480 V, I <sub>D</sub> =	-74	-	19	38	
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =	= 10 V, R <sub>q</sub> =	9.1 Ω	-	35	70	ns
Fall time	t <sub>f</sub>		5		-	15	30	
Gate input resistance	Rg	f = 1	MHz, open	drain	0.38	0.75	1.5	Ω
Drain-Source Body Diode Characteristi	cs	•				•		
Continuous source-drain diode current	I <sub>S</sub>	MOSFET syml showing the	ool		-	-	13	•
Pulsed diode forward current	I <sub>SM</sub>	integral revers p - n junction of			-	-	32	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °	C, I <sub>S</sub> = 7 A,	V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>				-	281	-	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 2$	5 °C, I <sub>F</sub> = I <sub>S</sub> 100 Α/μs, V	= 7 A, 25 \/	-	3.4	-	μC
Reverse recovery current	I <sub>RRM</sub>		100 <i>r</i> vµs, v	K – 23 V	-	22	-	A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

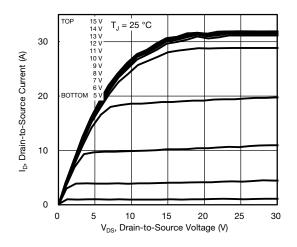


Fig. 1 - Typical Output Characteristics

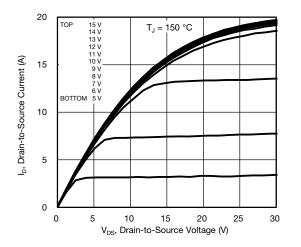
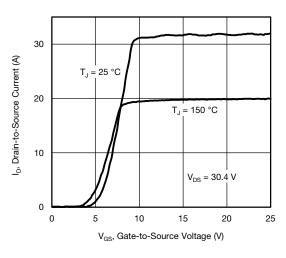


Fig. 2 - Typical Output Characteristics





3.0 R<sub>DS(on)</sub>, Drain-to-Source On-Resistance 2.5 2.0 (Normalized) 1.0 10 0.5 0 -60 -40 -20 0 20 40 60 80 100 120 140 160 T<sub>J</sub>, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

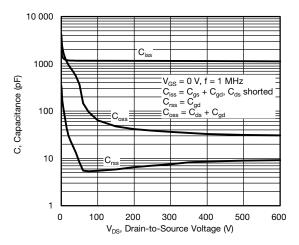


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

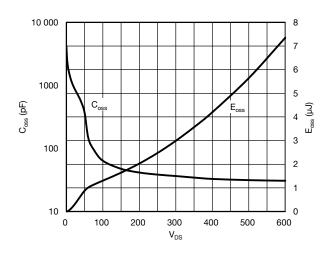


Fig. 6 -  $C_{\rm oss}$  and  $E_{\rm oss}$  vs.  $V_{\rm DS}$ 

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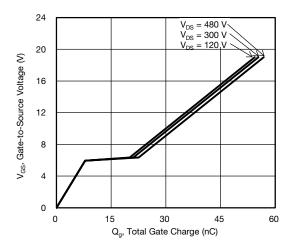


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

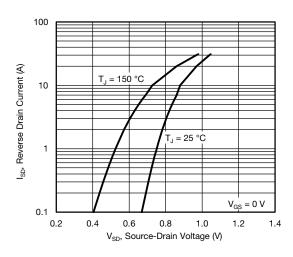


Fig. 8 - Typical Source-Drain Diode Forward Voltage

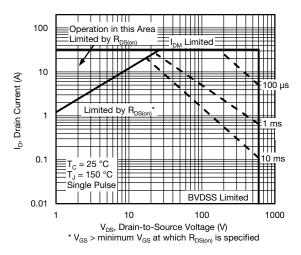


Fig. 9 - Maximum Safe Operating Area

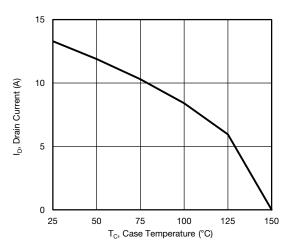


Fig. 10 - Maximum Drain Current vs. Case Temperature

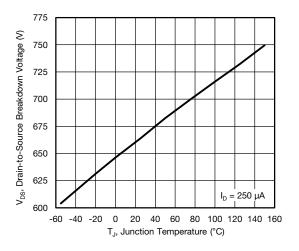
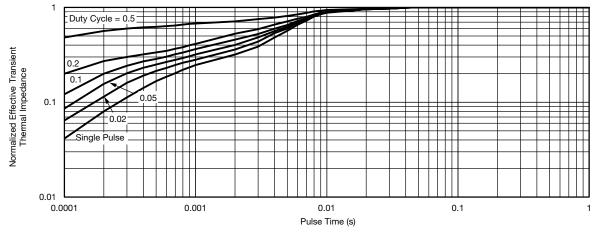


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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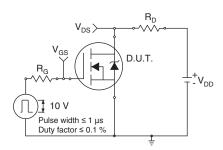


Fig. 13 - Switching Time Test Circuit

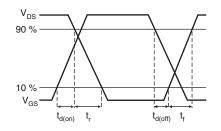


Fig. 14 - Switching Time Waveforms

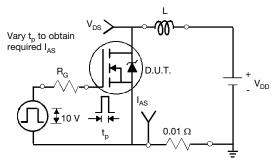


Fig. 15 - Unclamped Inductive Test Circuit

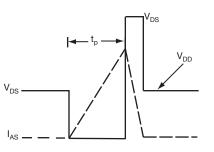


Fig. 16 - Unclamped Inductive Waveforms

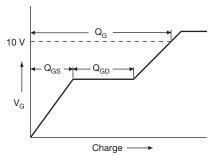


Fig. 17 - Basic Gate Charge Waveform

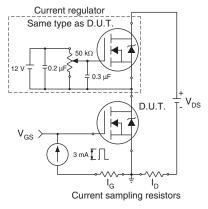


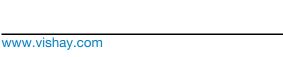
Fig. 18 - Gate Charge Test Circuit

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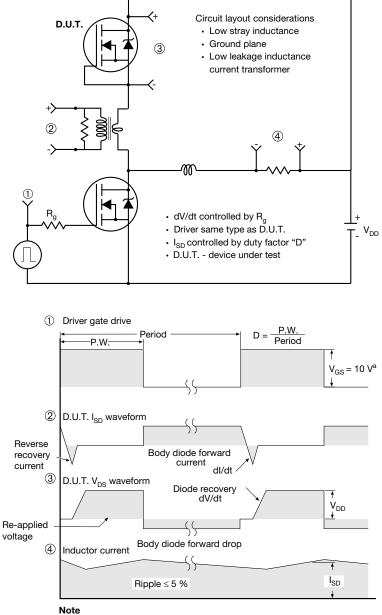
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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 19 - For N-Channel

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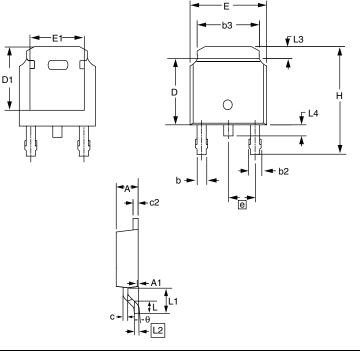
SHAY



# **Package Information**

**Vishay Siliconix** 

### **TO-252AA (HIGH VOLTAGE)**



	MILLI	METERS	INCHES			
DIM.	MIN.	MAX.	MIN.	MAX.		
E	6.40	6.73	0.252	0.265		
L	1.40	1.77	0.055	0.070		
L1	2.74	2.743 REF		0.108 REF		
L2	0.508	3 BSC	0.020 BSC			
L3	0.89	1.27	0.035	0.050		
L4	0.64	1.01	0.025	0.040		
D	6.00	6.22	0.236	0.245		
Н	9.40	10.40	0.370	0.409		
b	0.64	0.88	0.025	0.035		
b2	0.77	1.14	0.030	0.045		
b3	5.21	5.46	0.205	0.215		
е	2.286	2.286 BSC		0.090 BSC		
А	2.20	2.38	0.087	0.094		
A1	0.00	0.13	0.000	0.005		
С	0.45	0.60	0.018	0.024		
c2	0.45	0.58	0.018	0.023		
D1	5.30	-	0.209	-		
E1	4.40	-	0.173	-		
θ	0'	10'	0'	10'		

Notes

1. Package body sizes exclude mold flash, protrusion or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 0.10 mm per side.

2. Package body sizes determined at the outermost extremes of the plastic body exclusive of mold flash, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.

3. The package top may be smaller than the package bottom.

4. Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.10 mm total in excess of "b" dimension at maximum material condition. The dambar cannot be located on the lower radius of the foot.



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### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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